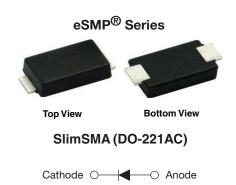
COMPLIANT

HALOGEN FREE



Vishay Semiconductors

Hyperfast Rectifier, 2 A FRED Pt®



LINKS TO ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS				
I _{F(AV)}	2 A			
V_R	200 V			
V _F at I _F	0.72 V			
t _{rr}	25 ns			
T _J max.	175 °C			
Package	SlimSMA (DO-221AC)			
Circuit configuration	Single			

FEATURES

Hyperfast recovery time, reduced Q_{rr}, and soft recovery

• 175 °C maximum operating junction temperature

Low forward voltage drop

· Low leakage current

• Specific for output and snubber operation

 Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C

Meets JESD 201 class 2 whisker test

 Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

DESCRIPTION / APPLICATIONS

State of the art hyperfast recovery rectifiers specifically designed with optimized performance of forward voltage drop and hyperfast recovery time.

The planar structure and the platinum doped life time control guarantee the best overall performance, ruggedness and reliability characteristics.

These devices are intended for use in snubber, boost, lighting, as high frequency rectifiers and freewheeling diodes.

The extremely optimized stored charge and low recovery current minimize the switching losses and reduce power dissipation in the switching element.

MECHANICAL DATA

Case: SlimSMA (DO-221AC)

Molding compound meets UL 94 V-0 flammability rating **Terminals:** matte tin plated leads, solderable per

J-STD-002

Polarity: color band denotes cathode end

ABSOLUTE MAXIMUM RATINGS				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Peak repetitive reverse voltage	V _{RRM}		200	V
Average rectified forward current	I _{F(AV)}	T _C = 155 °C ⁽¹⁾	2	А
Non-repetitive peak surge current	I _{FSM}	T _J = 25 °C	65	A
Operating junction and storage temperatures	T _J , T _{Stg}		-65 to +175	°C

Note

(1) Device on PCB with 8 mm x 16 mm soldering lands

ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Breakdown voltage, blocking voltage	V_{BR}, V_{R}	I _R = 100 μA	200	-	-	
Forward voltage	V _F	I _F = 2 A	-	0.85	0.93	V
i orward voltage	٧F	I _F = 2 A, T _J = 125 °C	-	0.72	0.77	
Reverse leakage current	I _R	V _R = V _R rated	-	-	2	uА
		$T_J = 125 ^{\circ}\text{C}, V_R = V_R \text{rated}$	-	1	8	μΑ
Junction capacitance	C _T	V _R = 200 V	-	10	-	pF



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DYNAMIC RECOVERY CHARACTERISTICS (T _J = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
		$I_F = 1.0 \text{ A}, dI_F/dt = 50 \text{ A/}\mu\text{s}, V_R = 30 \text{ V}$		-	25	-	20
Davis and a second distance	+	I _F = 0.5 A, I _R = 1 A, I _{rr} = 0.25 A		-	ı	25	
Reverse recovery time	t _{rr}	T _J = 25 °C		-	17	-	ns
		T _J = 125 °C		-	24	-	
Peak recovery current I _{RRM}	T _J = 25 °C	$I_F = 2 A$ $dI_F/dt = 200 A/\mu s$ $V_B = 160 V$	-	2	-	Α	
	T _J = 125 °C		-	3	-	_ ^	
Reverse recovery charge Q _{rr}	0	T _J = 25 °C	••	=	17	-	nC
	T _J = 125 °C		-	37	-	IIC	

THERMAL - MECHANICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified)						
PARAMETER	SYMBOL	TEST CONDITIONS	TEST CONDITIONS MIN. TYP. MAX.		MAX.	UNITS
Maximum junction and storage temperature range	T _J , T _{Stg}		-65	-	175	°C
Thermal resistance, junction to mount	R _{thJM}	Device mounted on PCB with 8 mm x 16 mm soldering lands	-	-	12	°C/W
Thermal resistance, junction to ambient	R _{thJA}	Device mounted on PCB with 2 mm x 3.5 mm soldering lands	-	-	115	C/VV
Approximate weight				0.03		g
			0.0011		oz.	
Marking device		Case style SlimSMA (DO-221AC)		21	1 2	

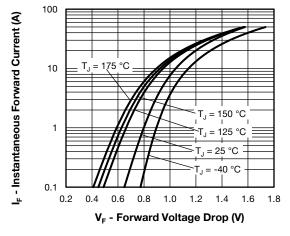


Fig. 1 - Typical Forward Voltage Drop Characteristics

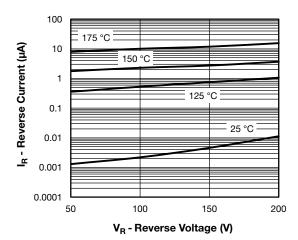


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

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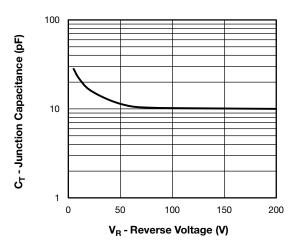


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

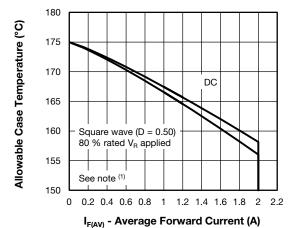
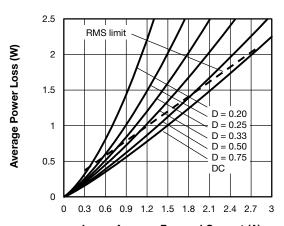


Fig. 4 - Maximum Allowable Case Temperature vs. Average Forward Current



I_{F(AV)} - Average Forward Current (A)

Fig. 5 - Forward Power Loss Characteristics

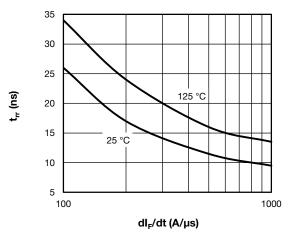


Fig. 6 - Typical Reverse Recovery Time vs. dI_F/dt

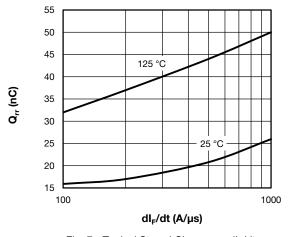
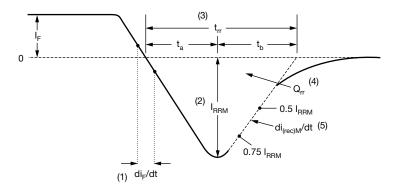


Fig. 7 - Typical Stored Charge vs. dl_F/dt

Note

 $\begin{array}{ll} \text{(1)} & \text{Formula used: } T_C = T_J - (\text{Pd} + \text{Pd}_{\text{REV}}) \times R_{\text{thJC}}; \\ \text{Pd} = & \text{forward power loss} = I_{\text{F(AV)}} \times V_{\text{FM}} \text{ at } (I_{\text{F(AV)}}/D) \text{ (see Fig. 6)}; \\ \text{Pd}_{\text{REV}} = & \text{inverse power loss} = V_{\text{R1}} \times I_{\text{R}} \text{ (1 - D)}; I_{\text{R}} \text{ at } V_{\text{R1}} = \text{rated } V_{\text{R}} \\ \end{array}$

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- (1) di_F/dt rate of change of current through zero crossing
- (2) I_{RRM} peak reverse recovery current
- (3) t_{rr} reverse recovery time measured from zero crossing point of negative going I_F to point where a line passing through 0.75 I_{RRM} and 0.50 I_{RRM} extrapolated to zero current.
- (4) $\rm Q_{rr}$ area under curve defined by $\rm t_{rr}$ and $\rm I_{RRM}$

$$Q_{rr} = \frac{t_{rr} \times I_{RRM}}{2}$$

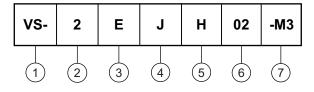
(5) di_{(rec)M}/dt - peak rate of change of current during t_b portion of t_{rr}

Fig. 8 - Reverse Recovery Waveform and Definitions

ORDERING INFORMATION TABLE

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Device code



- Vishay Semiconductors product
- 2 Current rating (2 = 2 A)
- 3 Circuit configuration:

E = single diode

J = SlimSMA package

5 - Process type,

H = hyperfast recovery

6 - Voltage code (02 = 200 V)

7 - -M3 = halogen-free, RoHS-compliant, and terminations lead (Pb)-free

ORDERING INFORMATION (Example)					
PREFERRED P/N	QUANTITY PER REEL	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION		
VS-2EJH02-M3/6A	3500	3500	7"diameter plastic tape and reel		
VS-2EJH02-M3/6B	14 000	14 000	13"diameter plastic tape and reel		

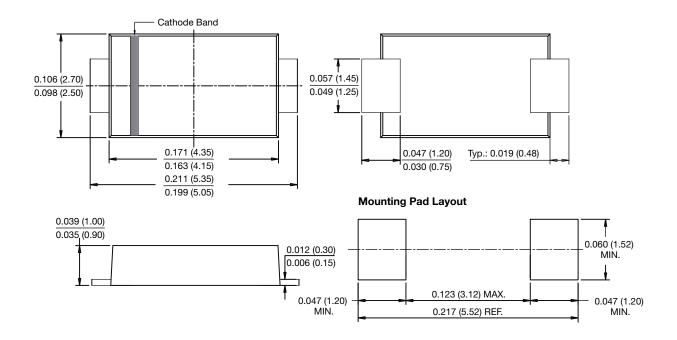
LINKS TO RELATED DOCUMENTS				
Dimensions	www.vishay.com/doc?95571			
Part marking information	www.vishay.com/doc?95562			
Packaging information	www.vishay.com/doc?88869			
SPICE model	www.vishay.com/doc?96861			



Vishay Semiconductors

DO-221AC (SlimSMA)

DIMENSIONS in inches (millimeters)





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